

Table 1. PIN DESCRIPTION

PIN	FUNCTION
U, Ū D, D FB, FB R, R V _{BB} V _{CC} , V _{CCO} V _{EE} NC	ECL Up Differential Outputs ECL Down Differential Outputs ECL Feedback Differential Inputs ECL Reference Differential Inputs Reference Voltage Output Positive Supply Negative Supply No Connect

Warning: All V_{CC} , V_{CCO} , and V_{EE} pins must be externally connected to Power Supply to guarantee proper operation.

Figure 1. 20-Lead Pinout (Top View)

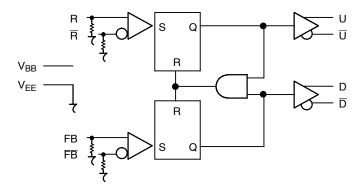


Figure 2. Logic Diagram

Table 2. ATTRIBUTES

Characte	Value			
ESD Protection	> 2	kV		
Moisture Sensitivity (Note 1)	Pb Pkg	Pb-Free Pkg		
	SOIC-20	Level 1	Level 3	
Flammability Rating	UL 94 V-0	@ 0.125 in		
Transistor Count	356 D	evices		
Meets or exceeds JEDEC Spec				

1. For additional information, see Application Note AND8003/D.

Table 3. MAXIMUM RATINGS

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V _{CC}	PECL Mode Power Supply	V _{EE} = 0 V		8 to 0	٧
V _{EE}	NECL Mode Power Supply	V _{CC} = 0 V		-8 to 0	٧
VI	PECL Mode Input Voltage NECL Mode Input Voltage	V _{EE} = 0 V V _{CC} = 0 V	$V_{I} \leq V_{CC}$ $V_{I} \geq V_{EE}$	6 to 0 -6 to 0	V V
l _{out}	Output Current	Continuous Surge		50 100	mA mA
I _{BB}	V _{BB} Sink/Source			± 0.5	mA
T _A	Operating Temperature Range			-40 to +85	°C
T _{stg}	Storage Temperature Range			-65 to +150	°C
θJΑ	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm	SOIC-20 SOIC-20	90 306	°C/W
$\theta_{\sf JC}$	Thermal Resistance (Junction-to-Case)	Standard Board	SOIC-20	30 to 35	°C/W
T _{sol}	Wave Solder Pb Pb-Free			265 265	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Table 4. LVPECL DC CHARACTERISTICS $V_{CC} = 3.3 \text{ V}, V_{EE} = 0 \text{ V}$ (Note 2)

			−40°C		25°C						
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I _{EE}	Power Supply Current		38	45		38	47		38	47	mA
V _{OH}	Output HIGH Voltage (Note 3)		2295	2420	2275	2345	2420	2275	2345	2420	mV
V _{OL}	Output LOW Voltage (Note 3)		1605	1745	1490	1595	1380	1490	1595	1680	mV
V _{IH}	Input HIGH Voltage (Single-Ended)			2420	2135		2420	2135		2420	mV
V _{IL}	Input LOW Voltage (Single-Ended)			1825	1490		1825	1490		1825	mV
V_{BB}	Output Voltage Reference			2.04	1.92		2.04	1.92		2.04	V
V _{IHCMR}	Input HIGH Voltage Common Mode Range (Note 7) Vpp < 500 mV Vpp ≧ 500 mV			3.3 3.3	1.2 1.4		3.3 3.3	1.2 1.4		3.3 3.3	V V
I _{IH}	Input HIGH Current			150			150			150	μΑ
I _{IL}	Input LOW Current Others R, FB	0.5 -300			0.5 -300			0.5 -300			μ Α μ Α

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- Input and output parameters vary 1:1 with V_{CC}. V_{EE} can vary ±D.3 V.
 Outputs are terminated through a 50 Ω resistor to V_{CC} 2 V.
 V_{IHCMR} min varies 1:1 with V_{EE}, max varies 1:1 with V_{CC}. The V_{IHCMR} range is referenced to the most positive side of the differential input signal. Normal operation is obtained if the HIGH level falls within the specified range and the peak-to-peak voltage lies between V_{PP}min and

Table 5. LVNECL DC CHARACTERISTICS V_{CC} = 0 V; V_{EE} = -3.0 V (Note 5)

		−40°C				25°C					
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I _{EE}	Power Supply Current		38	45		38	47		38	47	mA
V _{OH}	Output HIGH Voltage (Note 6)		-1005	-880	-1025	-955	-880	-1025	-955	-880	mV
V _{OL}	Output LOW Voltage (Note 6)	-1830	-1695	-1555	-1810	-1705	-1620	-1810	-1705	-1620	mV
V _{IH}	Input HIGH Voltage (Single-Ended)	-1165		-880	-1165		-880	-1165		-880	mV
V _{IL}	Input LOW Voltage (Single-Ended)	-1810		-1475	-1810		-1475	-1810		-1475	mV
V_{BB}	Output Voltage Reference	-1.38		-1.26	-1.38		-1.26	-1.38		-1.26	V
V _{IHCMR}	Input HIGH Voltage Common Mode Range (Note 7) Vpp < 500 mV Vpp ≧ 500 mV	-2.0 -1.8		-0.4 -0.4	-2.1 -1.9		-0.4 -0.4	-2.1 -1.9		-0.4 -0.4	V V
I _{IH}	Input HIGH Current			150			150			150	μΑ
I _{IL}	Input LOW Current Others R, FB	0.5 -300			0.5 -300			0.5 -300			μ Α μ Α

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- 5. Input and output parameters vary 1:1 with V_{CC}. V_{EE} can vary $\pm D.3$ V.
- 6. All loading with 50 Ω resistor to V_{CC} 2 V.
- V_{IHCMR} min varies 1:1 with V_{EE}, max varies 1:1 with V_{CC}. The V_{IHCMR} range is referenced to the most positive side of the differential input signal. Normal operation is obtained if the HIGH level falls within the specified range and the peak-to-peak voltage lies between V_{PP}min and 1 V.

Table 6. AC CHARACTERISTICS $V_{CC} = 3.3 \text{ V}$; $V_{EE} = 0.0 \text{ V}$ or $V_{CC} = 0 \text{ V}$; $V_{EE} = -3.3 \text{ V}$ (Note 8)

		−40°C		25°C							
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
Fmax	Maximum Toggle Frequency		TBD			TBD			TBD		GHz
t _{PLH} t _{PHL}	Propagation Delay R to U, FB to D	430 1200		630 1400	450 1250		650 1450	480 1370		680 1590	ps
V _{PP}	Input Swing (Differential Configuration) (Note 9)	150		1000	150		1000	150		1000	mV
t _{JITTER}	Cycle-to-Cycle Jitter		TBD			TBD			TBD		ps
t _r , t _f	Output Rise/Fall Times	175		475	175		475	175		475	ps

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- 8. V_{EE} can vary ±[0.3 V.
- 9. V_{PP(}min) is minimum input swing for which AC parameters guaranteed. The device has a DC gain of 4140.

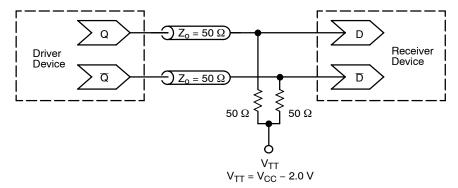


Figure 3. Typical Termination for Output Driver and Device Evaluation (See Application Note AND8020/D – Termination of ECL Logic Devices.)

ORDERING INFORMATION

Device	Package	Shipping [†]
MC10LVEL40DW	SOIC-20	38 Units / Rail
MC10LVEL40DWG	SOIC-20 (Pb-Free)	38 Units / Rail
MC10LVEL40DWR2	SOIC-20	1000 / Tape & Reel
MC10LVEL40DWR2G	SOIC-20 (Pb-Free)	1000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Resource Reference of Application Notes

AN1405/D - ECL Clock Distribution Techniques

AN1406/D - Designing with PECL (ECL at +5.0 V)

AN1503/D - ECLinPS™ I/O SPiCE Modeling Kit

AN1504/D - Metastability and the ECLinPS Family

AN1568/D - Interfacing Between LVDS and ECL

AN1672/D - The ECL Translator Guide

AND8001/D - Odd Number Counters Design

AND8002/D - Marking and Date Codes

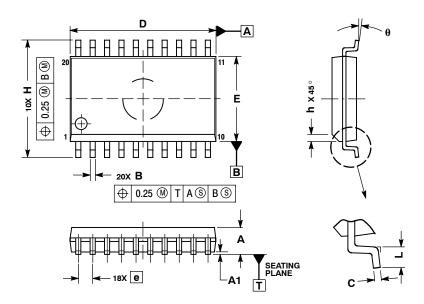
AND8020/D - Termination of ECL Logic Devices

AND8066/D - Interfacing with ECLinPS

AND8090/D - AC Characteristics of ECL Devices

PACKAGE DIMENSIONS

SO-20 WB CASE 751D-05 ISSUE G



NOTES:

- 1. DIMENSIONS ARE IN MILLIMETERS
- 2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
- 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION.
- 4. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE. 5. DIMENSION B DOES NOT INCLUDE DAMBAR
- 5. DIMENSION B DOES NOT INCLUDE DAMBAI PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIMETERS						
DIM	MIN	MAX					
Α	2.35	2.65					
A1	0.10	0.25					
В	0.35	0.49					
С	0.23	0.32					
D	12.65	12.95					
Е	7.40	7.60					
е	1.27	BSC					
Н	10.05	10.55					
h	0.25	0.75					
L	0.50	0.90					
Λ	0.0	70					

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